

## X-Ray Fluorescence Measurement For "High Reliability" Electronic Components

Aviation, Aerospace, and Military users of commercial off the shelf components are faced with a potentially dangerous parts shortage. It is possible that electronics thought to contain 3% tin lead specified for high reliability applications will be mislabeled and replaced with 0% lead components. As a result, tin-whiskers could occur resulting in dangerous consequences.

The newly implemented EU directives WEEE and RoHS will drastically change the types of components supplied to many industries including electronic equipment, printed circuit boards, and plastics. Those categories of electrical and electronic equipment that are exempt from WEEE RoHS face an even tougher and more critical challenge which could be the difference between life and death.

As of July 2006, the use of lead containing solders in some electronic and electrical equipment will be prohibited. Exempt from this ban are parts for "High Reliability" military, aerospace, and aviation applications.

Since the "High Reliability" portion of the overall market for solder is quite small, many suppliers are converting their production lines to the manufacture of only lead-free solder. As a result there are far fewer sources for the 3% lead solder that for decades has been the standard means of preventing tin whiskers. Without tin/lead solder, parts exposed to harsh environments such as high humidity, vibration, and temperature variation could short circuit causing fatal failures.

### How does one guarantee a critical part contains at least 3% lead?

Ensuring a critical part contains at least 3% lead or other

alloying elements can be accomplished with X-ray fluorescence measurement instruments. A quick, reliable, and non-destructive method for critical component identification for >3% lead has been developed by Fischer Technology. Using X-ray fluorescence combined with the state of the art Win FTM® 6 Software components can be clearly identified. By using this method, one can avoid the risks that might result should a parts supplier change to lead-free solder while maintaining the same part number. In addition, XRF measurement eliminates the risk that

mixed lots in which some parts contain the necessary lead while others are lead-free are shipped without being identified. Also, the X-ray fluorescence equipment will ensure in rework and repair situations that a lead-free component is not used to replace a required lead containing product.

Our material analysis instruments FISCHERSCOPE® X-RAY XAN® and XDAL® help you target components that are lead-free using X-ray fluorescence in many different fields of applications. They provide an effective solution giving



accurate levels of lead solder in products such as printed circuit boards and all electrical and electronic equipment. The instruments are easy to operate and safe. They provide fast, reliable, and easily readable results which can be obtained by operators with very little experience. If the part contains the necessary percentage of lead, the part is immediately identified as passing.

A screening process can be implemented to alleviate the risk of mixed lots. In addition the X-ray fluorescence equipment is capable of identifying the contents of the hazardous substances Pb, Hg, Cd, Cr and Br described in the EU directives WEEE and RoHS.



A high resolution video camera is included in the measuring instrument. This optical system, together with some variable collimators which control the X-ray beam, enables the analysis of the smallest specimen. The XDAL® instrument provides an extremely easy and user-friendly way to enable automatic measurements of specimens

on a large scale. Apart from the screening of the parts, the XRF also enables an accurate quantitative analysis. Our detection limits are Pb, Hg, Br < 10 ppm; Cd, Cr < 20 ppm. The measuring time, dependant on the object, ranges from 50 s - 200 s.

<p>FISCHERSCOPE®X-RAY</p>		
<p>Instrument type</p>	<p>XAN®</p>	<p>XDAL</p>
<p>Key applications</p>	<p>General analytics Analysis of alloys Coating analysis</p>	<p>Same use as XAN®, in addition: Automated measurements using an XY measuring stage. Lateral distribution analysis.</p>
<p>Measurement direction</p>	<p>From bottom to top</p>	<p>From top to bottom</p>
<p>Detector</p>	<p>PIN semiconductor diode with high energy resolution</p>	
<p>Collimators (A collimator is an aperture for shaping the primary X-ray beam. It determines the size of the measurement spot on the specimen.)</p>	<p>4 round collimators: 0.2 / 0.6 / 1.0 / 2.0 mm</p>	<p>Collimators: round: 0.1 / 0.3 / 0.6 mm slot-shaped: 0.5 x 0.15 mm</p>
<p>Measuring stage</p>	<p>Fixed specimen support</p>	<p>Programmable XY measuring stage, travel 256 x 230 mm</p>

**Fischer Technology • 1-800-243-8417 • www.Fischer-Technology.com**

**Helmut Fischer GmbH + Co.KG**  
Industriestraße 21  
71069 Sindelfingen, Germany  
Tel. (+49) 70 31 303-0  
Fax (+49) 70 31 303-79  
mail@helmut-fischer.de  
Internet: http://www.Helmut-Fischer.com



**Fischer Instrumentation (G.B.) Ltd.**  
Gordale Industrial Park  
Hannah Way, Pennington  
Lymington/Hampshire SO41 8JD, England  
Tel. (+44) 1590-684100, Fax (+44) 1590-684110  
mail@fischergb.co.uk  
Internet: http://www.fischergb.co.uk



**Fischer Technology, Inc.**  
750 Marshall Phelps Road  
Windsor, Ct. 06095, USA  
Tel. (+1) 860 683-0781, Fax (+1) 860 688-8496  
info@fischer-technology.com  
Internet: http://www.fischer-technology.com



**Sole Agent for Helmut Fischer GmbH+Co.KG, Germany:**

**Helmut Fischer Elektronik und Messtechnik AG**  
CH-6331 Hünenberg, Switzerland  
Tel. (+41) 41 785 08 00, Fax (+41) 41 785 08 01  
E-Mail: switzerland@helmutfischer.com

**Branch Offices of Helmut Fischer AG, Switzerland:**

**Fischer Instrumentation Electronique**  
78180 Montigny le Bretonneux, France  
Tel. (+33) (0) 1 30 58 00 58, Fax (+33) (0) 1 30 58 89 80  
E-Mail: france@helmutfischer.com

**Helmut Fischer S.R.L., Tecnica di Misura**  
20128 Milano, Italy  
Tel. (+39) 02 255 26 26, Fax (+39) 02 257 00 30  
E-Mail: italy@helmutfischer.com

**Fischer Instruments, S.A.**  
08018 Barcelona, Spain  
Tel. (+34) 93 309 79 16, Fax (+34) 93 485 05 94  
E-Mail: spain@helmutfischer.com

**Helmut Fischer Messtechnik B.V.**  
5827 GB Eindhoven, The Netherlands  
Tel. (+31) 40 248 22 55, Fax (+31) 40 242 88 85  
E-Mail: netherlands@helmutfischer.com

**Fischer Instruments K.K.**  
Saitama-ken 340-0012, Japan  
Tel. (+81) 48 929 3455, Fax (+81) 48 929 3451  
E-Mail: japan@helmutfischer.com

**Fischer Instrumentation (Far East) Ltd.**  
Kwai Chung, N.T., Hong Kong  
Tel. (+852) 24 20 11 00, Fax (+852) 24 87 02 18  
E-Mail: hongkong@helmutfischer.com

**Fischer Instrumentation (S) Pte Ltd.**  
Singapore 118529, Singapore  
Tel. (+65) 62 76 67 76, Fax (+65) 6276 76 67  
E-Mail: singapore@helmutfischer.com

**Nantong Fischer Instrumentation Ltd.**  
Shanghai 200437, P.R.C., China  
Tel. (+86) 21 6555 7455, Fax (+86) 21 6555 2441  
E-Mail: china@helmutfischer.com



ISO 9001  
SGS Registration  
No. 11699

Valid for Helmut Fischer AG and Branch Offices

